

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
Hiroyuki KOBAYASHI		11/06/2007
Junji FURUYA		11/06/2007
RECEIVING PARTY DATA		
Name:	IBIDEN CO., LTD	
Street Address:	1, Kandacho 2-chome	
City:	Ogaki-shi, Gifu	
State/Country:	JAPAN	
Postal Code:	503-8604	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11867256	
CORRESPONDENCE DATA		
Fax Number:	(703)519-9958	
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
Phone:	703-519-9951	
Email:	YNakamura@dcpatent.com	
Correspondent Name:	DITTHAVONG MORI & STEINER, P.C.	
Address Line 1:	918 Prince St.	
Address Line 4:	Alexandria, VIRGINIA 22314	
ATTORNEY DOCKET NUMBER:	01098_1044	
NAME OF SUBMITTER:	Masayasu Mori	
Total Attachments: 2		
source=01098-1044_signedAssignment#page1.tif		
source=01098-1044_signedAssignment#page2.tif		

OP \$40.00 11867256

500404387

PATENT
REEL: 020147 FRAME: 0882

Attorney Docket No.: 01098_1044

Client Docket No.: IB1108US

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we the undersigned, Hirovuki KOBAYASHI and Junji FURUYA, hereby sell, assign, and transfer to IBIDEN CO., LTD., a corporation of Japan, having a principal place of business at 1, Kandacho 2-chome, Ogaki-shi, Gifu 503-8604 Japan ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements that are disclosed in the application for the United States patent, entitled:

HONEYCOMB STRUCTURE MOUNTING BASE AND HONEYCOMB STRUCTURE INSPECTION APPARATUS

- ☐ which has been executed by the undersigned concurrently herewith,
☒ which was filed on October 4, 2007 and assigned Serial No. 11/867,256

and in to said application and all divisional, continuing, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;

agree that said Assignee may apply for and receive a patent or patents for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all assignments and powers of attorney; communicate to said Assignee, its successors, assigns, and representatives all facts known to the undersigned relating to said improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or representatives in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Each Inventor: Please Sign and Date Below:

NOV. - 6. 2007

Date

Hiroyuki Kobayashi

Name: Hiroyuki KOBAYASHI

NOV. - 6. 2007

Date

Junji Furuya

Name: Junji FURUYA